NTE1853
Integrated Circuit
Digital Filter for Compact Disc Digital Audio System

Features:

- 16–Bit Serial Data Input (Two's Complement)
- Interpolated Data Replaces Erroneous Data Samples
- −12dB Attenuation via the Active Low Attenuation Input Control (ATSB)
- Smoothed Trasitions Before and After Muting
- Two Identical Finite Impulse Response Transversal Filters each with a Sampling Rate of Four Times that of the Normal Digital Audio Data
- Digital Audio Output of 32–Bit Words Transmitted in Biphasemark Code

Applications:

- Compact Disc Digital Audio System
- Digital Filter

Absolute Maximum Ratings:

Supply Voltage Range (Pin24), V_{DD} . . . . −0.5V to +7.0V

Maximum Input Voltage Range, V_I . . . . −0.5V to V_{DD}+0.5V

Electrostatic Handling (Note 2), V_{ES} . . . . −1000V to +1000V

Operating Ambient Temperature Range, T_A . . . . −20° to +70°C

Storage Temperature Range, T_{stg} . . . . −65° to +150°C

Note 1. All outputs are short–circuit protected except the crystal oscillator output.

Note 2. Equivalent to discharging a 100pF capacitor through a 1.5Ω series resistor with a rise time of 15ns.

DC and AC Electrical Characteristics: (V_{DD} = 4.5 to 5.5V, V_{SS} = 0, T_A = −20° to +70°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Supply Voltage (Pin24)	V_{DD}		4.5	5.0	5.5	V
Supply Current (Pin24)	I_{DD}		–	180	–	mA

DC and AC Electrical Characteristics (Cont'd): (V_{DD} = 4.5 to 5.5V, V_{SS} = 0, T_A = −20° to +70°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
WSAB, DAAB						
Input Voltage, Low	V_{IL}		−0.3	–	+0.8	V
Input Voltage, High	V_{IH}		2.0	–	V_{DD}+0.5	V
Input Leakage Current	I_{LI}		−10	–	+10	µA
Input Capacitance	C_I		–	–	7	pF
EFAB, SDAB (Note 1)						
Input Voltage, Low	V_{IL}		−0.3	–	+0.8	V
Input Voltage, High	V_{IH}		2.0	–	V_{DD}+0.5	V
Input Leakage Current	I_{LI}	V_I = 0V	−10	–	–	µA
		V_I = V_{DD}	–	–	+50	µA
Input Capacitance	C_I		–	–	7	pF
CLAB, SCAB, $\overline{ATSB}$, $\overline{MUSB}$ (Note 2)						
Input Voltage, Low	V_{IL}		−0.3	–	+0.8	V
Input Voltage, High	V_{IH}		2.0	–	V_{DD}+0.5	V
Input Leakage Current	I_{LI}	V_I = 0V	−30	–	–	µA
		V_I = V_{DD}	–	–	+10	µA
Input Capacitance	C_I		–	–	7	pF
Output XOUT						
Mutual Conductance at 100kHz	G_M		1.5	–	–	mA/V
Small–Signal Voltage Gain	A_V	$A_V = G_M \times R_O$	3.5	–	–	V/V
Input Capacitance	C_I		–	–	10	pF
Feedback Capacitance	C_{FB}		–	–	5	pF
Output Capacitance	C_O		–	–	10	pF
Input Leakage Current	I_{LI}		−10	0	+10	µA
Slave Clock Mode						
Input Voltage (Peak to Peak)	$V_{I(P–P)}$	Note 3	3.0	–	V_{DD}+0.5	V
Input Voltage, Low	V_{IL}	Note 3	0	–	1	V
Input Voltage, High	V_{IH}	Note 3	3.0	–	V_{DD}+0.5	V
Input Rise Time	t_R	Note 4	–	–	20	ns
Input Fall Time	t_F	Note 4	–	–	20	ns
Input High Time at 2V (Relative to Clock Period)	t_{HIGH}		35	–	65	%

Note 1. Inputs EFAB and SDAB both have internal pull–downs.
Note 2. Inputs CLAB, SCAB, $\overline{ATSB}$, and $\overline{MUSB}$ have internal pull–ups.
Note 3. The minimum peak–to–peak voltage can be reduced to 2V if the output XSYS is not being used. Similarly V_{IH} can be reduced to 2.4V (Min). All other levels remain the same.
Note 4. Reference levels = 10% and 90%.

DC and AC Electrical Characteristics (Cont'd): (V_{DD} = 4.5 to 5.5V, V_{SS} = 0, T_A = −20° to +70°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
DABD, CLBD, WSBD						
Output Voltage, Low	V_{OL}	I_{OL} = 1.6mA	0	–	0.4	V
Output Voltage, High	V_{OH}	$-I_{OH}$ = 0.2mA	2.4	–	V_{DD}	V
Load Capacitance	C_L		–	–	50	pF
XSYS (Note 5)						
Output Voltage, Low	V_{OL}		0	–	0.4	V
Output Voltage, High	V_{OH}		2.4	–	V_{DD}	V
Load Capacitance	C_L		–	–	50	pF
DOBM						
Voltage Across a 75Ω Load via Attenuator (Peak–to–Peak)	$V_{L(P–P)}$		0.4	–	0.6	V

Note 5. The output current conditions are dependent on the drive conditions. When a crystal oscillator is being used, the output current capability is I_{OL} = +1.6mA; I_{OH} = −0.2mA. But if a slave input is being used, the output currents are reduced to I_{OL} = +0.2mA; I_{OH} = −0.2mA.

Timing Characteristics:

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Operating Frequency (XTAL)	f_{XTAL}		10.16	11.2896	12.42	MHz
Inputs						
SCAB, CLAB (Note 6)						
SCAB Clock Frequency (Burst Clock)	f_{SCAB}		–	2.8224	–	MHz
CLAB Clock Frequency	f_{CLAB}	Note 7	–	2.8224	–	MHz
			–	1.4112	–	MHz
Clock Low Time	t_{CKL}		110	–	–	ns
Clock High Time	t_{CKH}		110	–	–	ns
Input Rise Time	t_R		–	–	20	ns
Input Fall Time	t_F		–	–	20	ns
DAAB, WSAB, EFAB (Note 8)						
Data Setup Time	t_{SU}, t_{DAT}		40	–	–	ns
Data Hold Time	t_{HD}, t_{DAT}		0	–	–	ns
Input Rise Time	t_R		–	–	20	ns
Input Fall Time	t_F		–	–	20	ns

Note 6. Reference levels = 0.8V and 2.0V

Note 7. The signal CLAB can run at either 2.8MHz ($^1/_4$ system clock) or 1.4MHz ($^1/_8$ system clock) under typical conditions. It does not have a minimum or maximum frequency, but is limited to being $^1/_4$ or $^1/_8$ of the system clock frequency.

Note 8. Input setup and hold times measured with respect to clock input from A–chip (CLAB). Reference levels = 0.8V and 2.0V.

Timing Characteristics (Cont'd):

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
SDAB (Note 9)						
Subcode Data Setup Time	t_{SU}, t_{SDAT}		40	–	–	ns
Subcode Data Hold Time	t_{HD}, t_{SDAT}		0	–	–	ns
Input Rise Time	t_R		–	–	20	ns
Input Fall Time	t_F		–	–	20	ns
Outputs						
WSBD (Note 6 & Note 10)						
Word Select Setup Time	t_{SU}, t_{WS}		40	–	–	ns
Word Select Hold Time	t_{HD}, t_{WS}		0	–	–	ns
WSBD (Note 6)						
Output Rise Time	t_R		–	–	20	ns
Output Fall Time	t_F		–	–	20	ns
DABD (Note 6 & Note 10)						
Data Setup Time	t_{SU}, t_{DATD}		40	–	–	ns
Data Hold Time	t_{HD}, t_{DATD}		0	–	–	ns
Outputs (Cont'd)						
DABD (Note 6)						
Output Rise Time	t_R		–	–	20	ns
Output Fall Time	t_F		–	–	20	ns
CLBD (Note 6 & Note 10)						
Clock Period	t_{CK}		161	177	197	ns
Clock Low Time	t_{CKL}		65	–	–	ns
Clock High Time	t_{CKH}		65	–	–	ns
Clock Setup Time	t_{SU}, t_{CLD}		40	–	–	ns
Clock Hold Time	t_{HD}, t_{CLD}		0	–	–	ns
CLBD (Note 6)						
Output Rise Time	t_R		–	–	20	ns
Output Fall Time	t_F		–	–	20	ns
DABD (Note 6 & Note 11)						
Data Setup Time	t_{SU}, t_{DATBD}		40	–	–	ns
Data Hold Time	t_{HD}, t_{DATBD}		60	–	–	ns

Note 6. Reference levels = 0.8V and 2.0V
Note 7. The signal CLAB can run at either 2.8MHz ($^1/_4$ system clock) or 1.4MHz ($^1/_8$ system clock) under typical conditions. It does not have a minimum or maximum frequency, but is limited to being $^1/_4$ or $^1/_8$ of the system clock frequency.
Note 8. Input setup and hold times measured with respect to clock input from A–chip (CLAB). Reference levels = 0.8V and 2.0V.
Note 9. Input setup and hold times measured with respect to subcode burst clock input from A–chip (SCAB). Reference levels = 0.8V and 2.0V.
Note 10. Output setup and hold times measured with respect to system clock output (XSYS).
Note 11. Output setup and hold times measured with respect to clock output (CLBD).

Timing Characteristics (Cont'd):

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
WSBD (Note 6 & Note 11)						
Word Select Setup Time	t_{SU}, t_{DATWSD}		40	–	–	ns
Word Select Hold Time	t_{SU}, t_{DATWSD}		60	–	–	ns
DOBM (Note 12)						
Output Rise Time	t_R		–	–	20	ns
Output Fall Time	t_F		–	–	20	ns
Data Bit 0 Pulse Width High	$t_{HIGH(0)}$		–	354	–	ns
Data Bit 0 Pulse Width Low	$t_{LOW(0)}$		–	354	–	ns
Data Bit 1 Pulse Width High	$t_{HIGH(1)}$		–	177	–	ns
Data Bit 1 Pulse Width Low	$t_{LOW(1)}$		–	177	–	ns
XSYS						
Output Rise Time	t_R	Note 6	–	–	20	ns
Output Fall Time	t_F	Note 6	–	–	20	ns
Output High Time at 2V (Relative to Clock Period)	t_{HIGH}		35	–	65	%

Note 6. Reference levels = 0.8V and 2.0V
Note 11. Output setup and hold times measured with respect to clock output (CLBD).
Note 12. Output rise and fall times measured between the 10% and 90% levels; the data bit pulse width measured at the 50% level.

Pin Connection Diagram

WSAB	1	24	V_{DD}
CLAB	2	23	$\overline{MUSB}$
DAAB	3	22	$\overline{ATSB}$
EFAB	4	21	N.C.
N.C.	5	20	N.C.
SCAB	6	19	N.C.
SDAB	7	18	WSDB
N.C.	8	17	N.C.
X_{SYS}	9	16	CLBD
X_{OUT}	10	15	DABD
X_{IN}	11	14	DOBM
V_{SS}	12	13	TEST

24   13

1   12

1.300 (33.02) Max

.225 (5.73) Max

.100 (2.54)

1.100 (27.94)

.520 (13.2)

.600 (15.24)

.126